

# **Connector Datasheet**

### PT61301XX21

Pitch 1.27 pin header Single row SMT without post SH

Prepared: Hyde		Approved: ADAM		
Checked: FEIDI		Customer:		
Version	Changed Reason		Changed by	Date
01	Original version		Hyde	20191003

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### TECHNICAL INFORMATION

#### **MATERIALS**

- Housing: Thermoplastic High Temperature, UL 94V-0.
- Contact: Copper Alloy, Reference Drawing Description.
- Gold flash plated overall

### **ELECTRICAL PERFORMANCE**

- Current Rating: 1A Max. / Pin
- Voltage Rating: 30V DC Max.

## MECHANICAL PERFORMANCE

- Mating force: 220g Max. / Pin
- Unmating force: 20g Min. / Pin
- Contact Retention Force : Male: 300gf / pin Min.
- Durability: 100 cycles

### **PACKING**

Box



### PSGTeK Electronic Pvt. Ltd

#### **TEST REQUIREMENTS AND PROCEDURES SUMMARY**

Test Description	Requirement	PROCEDURED		
Examination of product	Meets requirements of product drawing and Specification.	Visual inspection No physical damage		
Electrical				
Contact Resistance	40mΩ Max. After Test 60mΩ Max.	EIA-364-23C		
Insulation Resistance	1000MΩ Min. at 500V DC / 2min.	EIA-364-21-E		
Dielectric Withstanding Voltage	No breakdown at 500V RMS	EIA-364-20-E		
MECHANICAL				
Durability	100 Cycles	EIA-364-09C		
Mating Force	220gf Max. /Pin	Speed 25±3mm/minute		
Un-Mating Force	20gf Max. /Pin	Speed 25±3mm/minute		
Contact Retention Force	300gf Min./Pin	EIA-364-29C		
ENVIRONMENTAL				
Humidity	Meets requirements of product drawing and electrical specification.	EIA-364-31C method II Condition A		
Salt spray	Meets requirements of product drawing and electrical specification.	Temperature: 35°C ± 2°C Density of salt water: 5 ± 1% Period: 4hours		
Low Temperature	Meets requirements of product drawing and electrical specification	The connector housing shall be store at temperature of -25 ± 3°C for 48hours		
Dry heat	Meets requirements of product drawing and electrical specification	The connector housing shall be store at temperature of 85 ± 2°C for 96hours EIA-364-17C		
PHYSICAL	<del>)</del>			
Solderability	The test area shall be covered more than 95% of immersed area with flash solder	Solder Temperature: 245 $^{\circ}$ C ± 5 $^{\circ}$ C Immersion Period: 3 $\pm$ 0.5sec.		
Resistance to Soldering Heat	Without deformation of case or excessive loosen. Electrical characteristics shall be satisfied	Place the connector on the P.C. Board, then immerse the solder pin up to the surface of the board in the solder bath at $260^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 5 sec.(Included $245^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 10 sec.)		

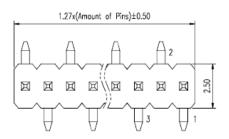
Figure 1

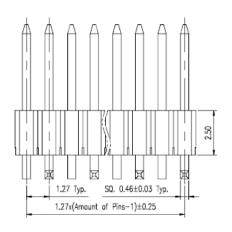
NOTE: Shall meet visual requirements, show no physical damages.

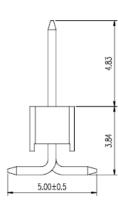


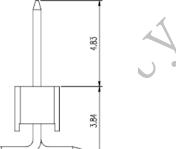
# Component Configuration and Dimensions

PT061301XX21=> XX: Amount of Pins

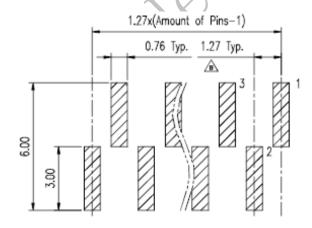








# Pins assignment for PCB Layout

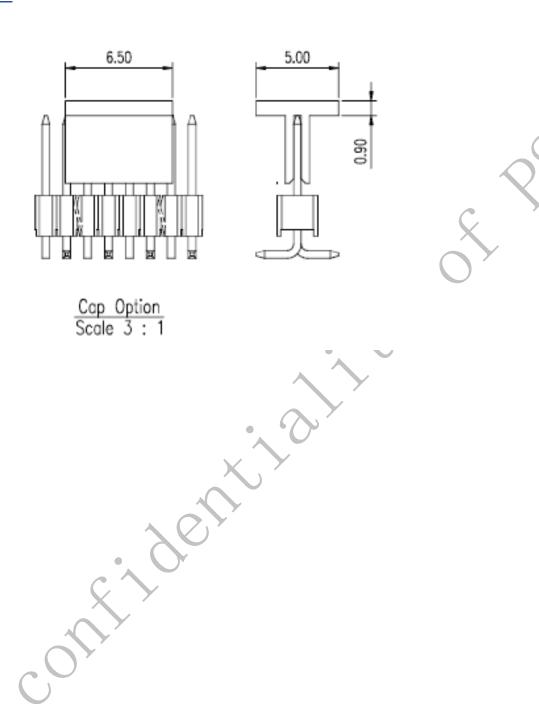


Recommended P.C.B. Layout Layout Tolerance = ± 0.05mm

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# **Others**



Note: The product specification only for standard product